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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Kuon MIYAZAKI et al.

Group Art Unit : Not Yet Assigned

Appl. No. : 10/567,355

(National Stage of PCT/JP2004/011848)

I.A. Filed : August 18, 2004

Examiner : Not Yet Assigned

For : PHOTSENSITIVE COMPOSITION AND CURED PRODUCTS
THEREOF

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§1.97-1.98, Applicants hereby bring the following information to the attention of the Examiner in charge of the above-identified application, which includes information cited and discussed in the specification and the International Search Report issued in connection with International Patent Application No. PCT/JP2004/011848, of which the present application is the U.S. National Stage Application. A copy of the International Search Report was enclosed with the papers when entering the U.S. National Stage on February 6, 2006. The Examiner is invited to review these materials to inspect the relevance indicated during international examination with respect to the documents cited therein. The following is a list of the documents cited in the above-noted documents:

- (1) U.S. Patent No. 3,794,576;
- (2) Japanese Laid-open Patent Publication No. HEI 6-298911, together with an English language abstract of the same;
- (3) Japanese Laid-open Patent Publication No. HEI 9-328634, together with an English language abstract of the same;
- (4) Japanese Patent No. 2667934, together with patent family members U.S. Patent No. 5,437,964 and U.S. Patent No. 5,510,226;
- (5) Japanese Laid-open Patent Publication No. HEI 4-120182, together with an English language abstract of the same;
- (6) Japanese Laid-open Patent Publication No. HEI 9-183928, together with an English language abstract of the same;
- (7) Japanese Patent No.1266325 (Japanese Patent Publication No. SHO 59-42688), together with patent family members U.S. Patent No. 4,256,828 and U.S. Patent No. 4,318,766;
- (8) Japanese Laid-open Patent Publication No. 2001-527143, together with patent family members U.S. Patent Application Publication No. 2002/0134449 and U.S. Patent No. 6,548,566;
- (9) Japanese Laid-open Patent Publication No. 2002-509982, together with patent family members U.S. Patent Application Publication No. 2004/0010050; U.S. Patent No. 6,136,497; U.S. Patent No. 6,413,697; and U.S. Patent Application Publication No. 2002/0177073;
- (10) Japanese Patent No. 3251188, together with an English language abstract of the same;

- (11) Japanese Laid-open Patent Publication No. 2002-69269, together with an English language abstract of the same;
- (12) TSUNOOKA et al., "Industrial Development of Cationic Curing Technology," Material Stage, published by Technical Information Association, Vol. 2, No. 2, pp. 39-92 (May 10, 2002);
- (13) Japanese Laid-open Patent Publication No. 2002-69159, together with an English language abstract of the same;
- (14) Japanese Laid-open Patent Publication No. HEI 6-100665, together with an English language abstract of the same;
- (15) Japanese Laid-open Patent Publication No. 2001-335621, together with an English language abstract of the same;
- (16) Japanese Laid-open Patent Publication No. HEI 5-136575, together with an English language abstract of the same;
- (17) Japanese Laid-open Patent Publication No. 2000-136230, together with an English language abstract of the same;
- (18) Japanese Laid-open Patent Publication No. HEI 11-184086, together with an English language abstract of the same; and
- (19) International Patent Publication No. WO 1996/035756, together with patent family member European Patent Publication No. EP 0 831 127.

Applicants note that documents (1)-(12) are cited on page 4 of the specification of the present application, and documents (13)-(19) were cited in the International Search Report.

Also, Applicants call to the Examiner's attention the following documents:

International Patent Publication No. WO 03/100524;

Japanese Laid-open Patent Publication No. HEI 10-102026, together with
an English language abstract of the same;

U.S. Patent No. 5,079,129; and

U.S. Patent No. 5,300,380.


Further to 37 C.F.R. §1.98 (a)(2)(ii), copies of the U.S. patents and the
U.S. patent application publications are not enclosed herewith. However, if
copies are needed, the Examiner is respectfully requested to contact the
undersigned.

Applicants respectfully request that the Examiner consider the above
material and cite the same. Copies of the above-noted foreign documents are
attached hereto and all of the above-noted documents are listed on the attached
PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on
the attached Form and to return a copy of the completed Form to Applicants with
the next official communication in the present application.

Applicants note that an Office Action on the merits has not issued in the
present application, and thus no fee is believed necessary to ensure
consideration of the submitted material.

Should the Examiner have any questions, the Examiner is invited to
contact the undersigned at the below-listed telephone number.

Respectfully Submitted,
Kuon MIYAZAKI et al.



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FORM PTO-1449

Department of Commerce
Patent and Trademark OfficeAtty. Docket
P29200Application No.
10/567,355INFORMATION DISCLOSURE STATEMENT
BY APPLICANT

(Use several sheets if necessary)

Applicant
Kuon MIYAZAKI et al.Filing Date
August 18, 2004Group
Unknown

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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| | 1 | English Language Abstract of JP 6-298911. |
| | 2 | English Language Abstract of JP 9-328634. |
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| | 5 | English Language Abstract of JP9-183928. - |
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| | 7 | English Language Abstract of JP 2002-69269. |
| | 8 | English Language Abstract of JP 2002-69159. |
| | 9 | English Language Abstract of JP6-100665. |

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO-1449

Department of Commerce
Patent and Trademark OfficeAtty. Docket
P29200Application No.
10/567,355INFORMATION DISCLOSURE STATEMENT
BY APPLICANT

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Applicant
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| | 10 | TSUNOOKA et al., "Industrial Development of Cationic Curing Technology," Material Stage, published by Technical Information Association, Vol. 2, No. 2, pp. 39-92 (May 10, 2002). |
| | 11 | English Language Abstract of JP 2001-335621. |
| | 12 | English Language Abstract of JP 5-136575. |
| | 13 | English Language Abstract of JP 2001-136230. |
| | 14 | English Language Abstract of JP 11-184086. |
| | 15 | English Language Abstract of JP 10-102026. |
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